



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	TLT807B0EPV	<b>Issued</b>	10. May 2021
<b>MA#</b>	MA001624870		
<b>Package</b>	PG-TSDSO-14-1	<b>Weight*</b>	64.09 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.910	2.98	2.98	29799	29799
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		146	
	non noble metal	zinc	7440-66-6	0.037	0.06		582	
	non noble metal	iron	7439-89-6	0.746	1.16		11645	
	non noble metal	copper	7440-50-8	30.306	47.29	48.52	472831	485204
wire	non noble metal	copper	7440-50-8	0.056	0.09	0.09	877	877
encapsulation	organic material	carbon black	1333-86-4	0.086	0.13		1338	
	plastics	epoxy resin	-	3.344	5.22		52171	
	inorganic material	silicondioxide	60676-86-0	25.150	39.24	44.59	392395	445904
leadfinish	non noble metal	tin	7440-31-5	1.644	2.57	2.57	25651	25651
plating	noble metal	silver	7440-22-4	0.135	0.21	0.21	2105	2105
glue	plastics	epoxy resin	-	0.168	0.26		2615	
	noble metal	silver	7440-22-4	0.503	0.78	1.04	7845	10460
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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